Associative Memory pattern matching for L1 track trigger for the HL-LHC CMS

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The High Luminosity LHC (HL-LHC) will deliver luminosities of up to $5 \times 10^{34}$ Hz/cm$^2$, with an average of about 140 overlapping proton-proton collisions per bunch crossing. These extreme pileup conditions place stringent requirements on the trigger system to be able to cope with the resulting event rates. A key component of the CMS upgrade for HL-LHC is a track trigger system, able to identify tracks with transverse momenta above 2 GeV/c already at the first-level trigger. We present here the status of the implementation of a prototype system based on the combination of Associative Memory custom ASIC and modern Field Programmable Gate Arrays (FPGA) devices, with the purpose to demonstrate the concept based on state-of-the-art technologies, and to direct the efforts of the necessary R&D toward a final system.

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Associative Memory pattern matching for L1 track trigger for the HL-LHC CMS

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Abstract. The High Luminosity LHC (HL-LHC) will deliver luminosities of up to $5 \times 10^{34}$ Hz/cm\textsuperscript{2}, with an average of about 140 overlapping proton-proton collisions per bunch crossing. These extreme pileup conditions place stringent requirements on the trigger system to be able to cope with the resulting event rates. A key component of the CMS upgrade for HL-LHC is a track trigger system, able to identify tracks with transverse momenta above 2 GeV/c already at the first-level trigger. We present here the status of the implementation of a prototype system based on the combination of Associative Memory custom ASIC and modern Field Programmable Gate Arrays (FPGA) devices, with the purpose to demonstrate the concept based on state-of-the-art technologies, and to direct the efforts of the necessary R&D toward a final system.

1 Introduction

The increase of the luminosity of the Large Hadron Collider (LHC) to $5 \times 10^{34}$ Hz/cm\textsuperscript{2}, foreseen in the High Luminosity (HL) upgrade scheduled for 2026, will bring the number of proton-proton interactions per bunch crossing up to about 200. The corresponding higher background will generate an unmanageable increase in the trigger rate of the ATLAS and CMS detectors if their trigger systems will keep the current threshold configurations in order to preserve their “physics analysis” capabilities.

One solution could come from the use of high-resolution information from Silicon Trackers, at the cost of adding a few microseconds of latency and with a large data rate with respect to the current L1-trigger. The trajectories of charged particles in CMS are helices since they are bent by the magnetic field generated by a solenoid. When a charged particle passes through the Silicon Tracker it releases a small amount of energy in the silicon modules and the passage of the particle is recorded (“hit”). The CMS tracker for the HL-LHC upgrade will be composed of six (seven) layers of silicon modules in the central (forward) region. Each proton-proton interaction can generate hundreds of charged particles so that the Silicon Tracker generates thousands of hits in each event. Having a multitude of hits, the reconstruction of the trajectory of charged particles in few microseconds becomes challenging.

CMS is exploring three different approaches to tackle this problem, two are based on track reconstruction done with Field Programmable Gate Array (FPGA) and one that will be explained in this report which is based on the use of Associative Memory (AM) and FPGA. The purpose of our R&D activity is to prove that this goal can be achieved by combining pattern recognition based on AM custom chip and computing capabilities available in state-of-the-art FPGA devices. Track finding

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Schematic overview of part of the system. An ATCA shelf accommodates ten PulsarIIb boards and each of them can accommodate two PRMs. Two types of PRM have been developed: one with a full AM chip configuration and one with two Xilinx Ultrascale FPGAs and a socket which can accommodate VIPRAM chips.

based on Associative Memories [5] has been successfully used in the CDF experiment [7] and, more recently, is being exploited in the Fast-Track processor [3, 4] for the ATLAS Level-2 trigger system.

The CMS outer tracker will be divided in 48 regions in $\eta$-$\phi$ (pseudo-rapidity and azimuthal angles) called trigger towers. In each trigger tower, the track finding will be performed using data from silicon modules belonging to that region. Each tower will receive an average of 100 hits per layer (the number of layers ranges from 6 to 7 depending on the pseudo-rapidity) in each bunch crossing. With the current technology we want to build a prototype of the system aiming to demonstrate that following the progress of the commercial devices and with a reasonable and affordable R&D we will be able to build the full system for the HL phase LHC.

2 Demonstrator System Overview

Several boards based on the ATCA technology, the Pulsar IIb boards [1], will collect data from each trigger tower. Each Pulsar IIb board can accommodate two Pattern Recognition Mezzanine (PRM) boards performing pattern recognition and track fitting. Figure 1 shows a schematic view of the prototype system.

Each PRM board contains one or two Xilinx FPGAs, implementing data flow management and track fitting, and one or multiple AM devices. Each PRM board receives and temporarily stores in a data-buffer full resolution hit data. Lower resolution data (called Super-Strips) are evaluated and transmitted to the AM chips. The AM chip behaves as a Content Addressable Memory (CAM) and quickly matches the Super-Strips with the pre-loaded patterns. Pre-loaded patterns are based on simulation of the tracks coming from the bunch crossing and of the tracker. Indeed, the tracks are mostly originating in a defined region of the detector and the curvature of the helices is defined within a certain region of interest ($p_T > 2$ GeV/$c$).

All the patterns are simultaneously compared with the input data for each layer. When a match is found on a layer, a match bit is set and it remains as such until the end of the event processing, when an internal reset signal is propagated. If in a given pattern a match is detected for all the layers, or for a majority of them, the pattern address is transmitted to the FPGA.

Only a subset of the Super-Strips are associated to relevant tracks, mapped into patterns stored in the AM chips. The full resolution data associated to these Super-Strips are retrieved from the FPGA data-buffer, filtered and propagated to the Track Fitting module. The processing time for each event in a PRM board will be of the order of few $\mu$s. Therefore it will be necessary to time-multiplex the data to $O(10)$ Pulsar boards using a round-robin mechanism. Tracks that are found from the PRM will be then transferred to the Global Trigger System. The final goal of the PRM board is to evaluate the
Figure 2. Left: INFN PRM mezzanine. Right: FNAL PRM mezzanine.

performance of the real-time system described above using start-of-the-art AM chips and to shape the necessary modifications to match the tight CMS bandwidth and processing time constraint of 4-5 $\mu$s.

For this purpose two prototype processors have been developed: the Pattern Recognition Mezzanine PRM05/06 at INFN and the FNAL PRM. The PRM05 processor is designed to combine the pattern recognition task [6] using the new version of the AM device with the precise track fitting [4], performed by the last generation of FPGA devices, to send out the track information to the higher trigger levels within a latency of few microseconds. PRM05 has a Xilinx Kintex7 FPGA (XC7K355T) and 16 AM chips. The board has been developed to accommodate AM05 devices, to test the basic functionality of the serial links, even if the number of patterns stored in each chip is modest (2k patterns).

A second version will use a 12 AM chip version 06 where the number of patterns per chip will be increased to 128k patterns for a total of 1.5 million patterns per PRM, which will provide a high efficiency of track reconstruction. The FPGA has the role of distributing the hits to AM chips, collecting the candidate tracks, performing a track fitting on them using a Principal Component Algorithm PCA [4] and then send out the results to the global Level-1 trigger. The direct connection between the FPGA and the AM chips has been chosen to eliminate daisy chains and to reduce as much as possible the latency of the Level-1 trigger decision and to integrate all the functionalities in one single board. An external low latency memory is added to increase the data storage capability of the device, in view of possible needs by the different fitting algorithms to be tested.

The FNAL PRM board has two Xilinx Ultrascale FPGAs and a socket which can accommodate the next-to-come VIPRAM [8] chip. One of the FPGA is used to emulate the AM chip using synthesized HDL code, while the other FPGA is used to store the hits and to fit the matched patterns. The emulated AM chip can store up to 4k patterns. This mezzanine cannot manage the patterns of a full trigger tower with high efficiency, but is designed to minimize the latency of the pattern finding process. Indeed, the FNAL PRM is equipped with a powerful FPGA with high speed serial links with data rates up to 16.3 Gbps, and the synthesized FPGA code has been designed with a low latency approach. With this PRM we want to show what we can achieve with the future AM custom chips.
The PRM mezzanine, see figure 2, is a custom 14.9 × 14.9 cm² printed circuit board housing the following components:

- FMC connectors (2x);
- Xilinx FPGA (1x INFN PRM, 2x FNAL PRM);
- Associative Memory devices (16x INFN PRM, 1x FNAL PRM);
- Power regulators;
- DDRII Pattern Memory (1x);

The two FMC connectors, compliant with the VITA 57.1 standard, are used to interface the PRM to the Pulsar IIb host board. They carry signals and power supply voltages. The host board provides 3.3 V and 12 V, with a maximum available power of 150 W. The power regulator group is used to generate the 1.0 V, 1.2 V, 1.8 V and 2.5 V voltages required by the FPGA, the AM devices and the pattern memory. Regarding the signal lines, 6 bidirectional high-speed serial links (up to 10 Gbps), with three links through each FMC connector, are used to send and retrieve data from the PRM with a total bandwidth in input and output up to 120 Gbps. Moreover, 68 additional LVDS pair pins are used for the slow configuration and monitoring purposes of the PRM and to provide additional bandwidth for the data transfer. The Xilinx FPGA manages the data flow inside the mezzanine. It receives and temporarily stores the full resolution hit data from the Pulsar IIb board and it evaluates and distributes to the 16 AM chips the lower resolution hit data used in the pattern recognition. Finally, the external pattern memory provides up to 18 Mbit for INFN PRM and up to 36 Mbit for FNAL PRM of memory resources to store a copy of the pattern banks of the AM chips.

The current INFN PRM mezzanine houses 16 AM custom chips version 05 (AM05). Each chip can store up to 2k patterns, corresponding to a total capacity of 32k patterns per PRM (128k patterns in the AM version 06 chip (AM06 available since beginning of 2016) to be released in the second quarter of 2016). Each pattern is made of 8 independent 16-bit words, one for each layer. The input data bus distribution from the FPGA to the AM chips uses a first 1-to-2 fan-out buffer to distribute data to the left and right quarters of the card, followed by two 1-to-4 fan-out buffers to distribute the data to the 4 AM chips in parallel. The input serial links can sustain a data rate of 2 Gbps, while the output data of each AM chip is connected directly to the FPGA using high speed serial lines running at 2.4 Gbps.

The FNAL RPM is equipped with two Xilinx Ultrascale 040/060 FPGAs, fast serial links connect the two FPGA with a data rate up to 16.3 Gbps. One of the FPGA is also fully connected with six high-speed serial links to the FMC connectors. The PRM is also provided with additional external communication links based of QSFP+ transceivers.

4 PRM hardware validation

Both PRM mezzanine boards were validated regarding the electrical circuitry and both showed the expected behavior. The JTAG connection to the FPGA was tested by programming it.

The INFN PRM mezzanine was tested using the test stand shown in figure 3. The test stand is composed of the PMR mezzanine, an adapter card, and an evaluation board. An HTG Virtex 6 evaluation board has been used for the main tests reported in this text. Since the HTG evaluation board has some limitation on the links towards the FMC connectors (only four high speed serial links connected and data rate limited to 6.2 Gbps), in order to test the fast serial links of the INFN PRM, an Ultrascale Evaluation board has been also used. The evaluation board is connected to the host PC.
via Ethernet. It provides power, LVDS parallel connections and high-speed serial connections to the PRM mezzanine. The IP-bus protocol is used to access devices in the Virtex 6 and in the PRM FPGAs (e.g.: control and status registers, source FIFOs containing test Stubs, monitoring FIFOs containing PRM outputs). All the serial links between the FPGAs and to/from the AM chips on the PRM board have been successfully tested. JTAG connections to the AM chips (4 JTAG chains with 4 AM chips each) have been tested in order to verify the possibility to configure and program the AM chips. The eight input links to each AM chip have been characterized. Pseudo Random Bit Sequences (PRBS) have been used to test the links between the FPGA and the AM chips. The FMC connector links have undergone tests by using a loopback card and the IBERT tool, provided by Xilinx, that allows measuring the Bit Error Rate (BER) and producing the corresponding eye diagrams. Signal integrity up to 8 Gbps has been tested by measuring the BER and the corresponding eye-scans in the receiver links of the PRM and in the receiver links of the Ultrascale board. The BER has been measured using a PRBS-7 sequence. The measured BER was less than $2 \times 10^{-15}$ in both directions. The power consumption of the board has been measured by powering and configuring the four groups of the AM chips, resulting in a static power consumption of about 40 watts. The mezzanine board has been successfully integrated with the Pulsar IIb board in Summer 2015. During these tests the mechanical and electrical compatibility have been verified and both the LVDS and high-speed fully tested.

The FNAL PRM mezzanine has been tested in a standalone configuration and with the Pulsar IIb board. The high speed serial links between the two FPGAs and towards the FMC connectors have been tested: between the FPGAs the links were validated at 16.3 Gbps while towards the FMC connectors they were validated at 10 Gbps. The LVDS links between the FPGAs and the FMC connectors were successfully validated. The QSFP+ transceivers were also tested and no errors were found in the transmitted pseudo-data.

## 5 PRM functionalities

On both PRM mezzanines a synthesized HDL code has been developed to carry on the functionalities needed for the track finding: hit memorization, hit retrieving, and hit fitting. The tracking algorithm implemented in both PRM boards consists of the following sequence of operations, see figure 4:

1. Full resolution hit data received by the host board are decoded and stored in a smart data buffer, called Data Organizer, and coarse resolution hit data Super-Strips are generated and transmitted to the AM chips;
2. AM chips perform pattern recognition on Super-Strip input data and identify sets of Super-Strips matching patterns “Roads” that are transmitted back to the FPGA;

3. Roads are used to retrieve from an external pattern memory (currently internal to the FPGA) the associated Super-Strips;

4. Stubs stored in the Data Organizer and belonging to the Super-Strips retrieved from the pattern memory are propagated to the filtering module;

5. The Super-Strips belonging to a road are filtered in such a way that only one candidate track is generated composed of no more than one hit per layer. The set of stubs belonging to the candidate track is sent to the Track Fitter module;

6. The Track Fitter performs the fitting algorithm using the full resolution data from the Data Organizer to evaluate the track helix parameters and the goodness of fit.

Two different track finding algorithm were developed. Each one was dedicated to fulfill the goal of the PRM mezzanines. In the case of the FNAL PRM mezzanine the algorithm focused on the reduction of the track finding latency, while in the case of INFN PRM mezzanine the algorithm focused on the handling of large pattern banks and multiple AM devices. The full chain of track finding has been developed and tested using HDL simulations and the real FPGAs for simple events. In both cases the latency owing to the hit retrieving, hit filtering, and hit fitting was about one microsecond. In the case of the INFN mezzanine additional and non-negligible latency is caused by the limited bandwidth of the serial links and a non-optimized output electronics of the AM05 device. It is worth mentioning that the AM05 chip has been developed for applications were the latency is not the main concern. An R&D phase to develop a faster and low-latency AM device is already ongoing.

6 Conclusions

Two PRM mezzanine boards and the relative software have been developed and tested. Further optimization of the algorithms and a new INFN PRM mezzanine equipped with AM06 will be done leading to the system prototype to be developed before the end of this year (2016). The current hardware and algorithm showed good performance and limited latency, demonstrating promising results in view of the final test of the system prototype.
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References